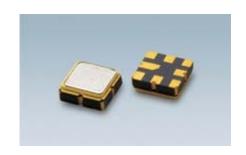


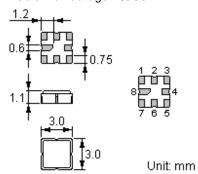
Features

- Low-loss RF filter for digital television
- Ceramic Package for Surface Mounted Technology (SMT)
- Lead-free Production and RoHS Compliance



Package Dimensions

Ceramic Package: QCC8D



Pin Configuration

1,2	Balance Input
5,6	Balance Output
3,7	To Be Grounded
4, 8	Case Ground

Marking



Top View, Laser Marking

"ND": Manufacturer's mark "F": SAW filter

"9394": Part number "•": Terminal 1

"*": Lot number (The code shown below varies in a 4-year cycle)

Code	1	2	3	4	5	6	7	8	9	10	11	12
2011	а	b	С	d	е	f	g	h	i	j	k	m
2012	n	р	q	r	S	t	u	٧	W	Х	у	z
2013	Α	В	С	D	Е	F	G	Н	J	K	L	М
2014	N	Р	Q	R	S	Т	U	V	W	Х	Υ	Z

Maximum Ratings

Rating		Value	Unit
Source Power	Р	0	dBm
DC Voltage	$V_{ m DC}$	0	V
Operating Temperature Range	T_{A}	-40 ~ +85	°C
Storage Temperature Range	$T_{ m stg}$	-50 ~ +95	°C



Electrical Characteristics

Operating temperature range: $T = -40 \, ^{\circ} C \, +85 \, ^{\circ} C$

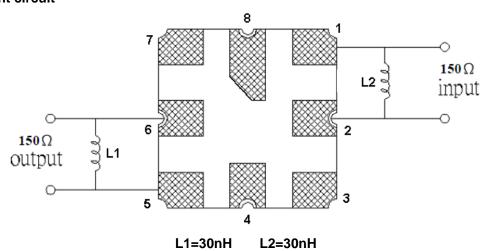
Terminating source impedance (difference): $Z_S = 150 \ \Omega //30 nH$ Terminating load impedance (difference): $Z_L = 150 \Omega //30 nH$

Characteristic		Min.	Тур.	Max.	Unit
Nominal frequency	f _C		1382.24	_	MHz
Bandwidth at -2dB αmax	IL	40	52		dB
Amplitude ripple (p-p) 1362.24 1402.24MHz	Δα		0.7	2.0	dB
Insertion Loss in 1362.24 1402.24MHz	Δα		2.2	5.0	MHz
Phase error 1362.24 1402.24MHz			5.0	6.5	deg
I/O VSWR 1362.24 1402.24MHz			1.7	2.5	
Relative attenuation (relative to αmax) 50.00 1300.18MHz 1464.3 1810.5 MHz 1810.5 4250 MHz 4250 6000MHz	α	46 46 35 30	50 52 40 39		dB

® RoHS Compliant

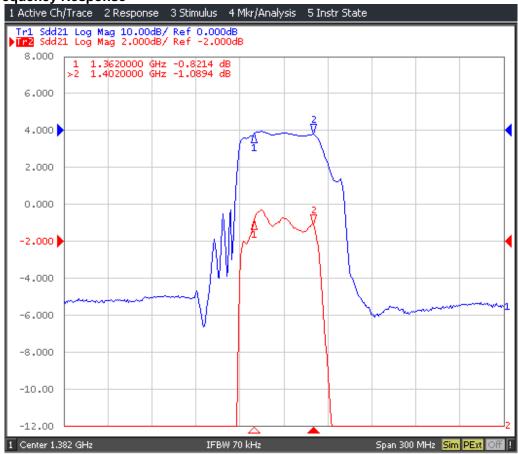
Electrostatic Sensitive Device

Measurement circuit





Typical Frequency Response





Stability Characteristics

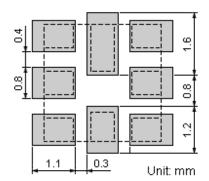
	Test item	Condition of test				
1	Mechanical shock	a) Drops: 3 times on concrete floor b) Height: 1.0 m				
2	Vibration resistance	(a) Frequency of vibration: 10~55Hz (c) Directions: X,Y and Z	(b) Amplitude: 1.5 mm (d) Duration: 2 hours			
3	Moisture resistance	(a) Condition: 40°C, 90~95% R.H. (c) Wait 4 hours before measurement	(b) Duration: 96 hours			
4	Climatic sequence	()	for 24 hours, 90~95% R.H. for 24 hours, 90~95% R.H.			
5	High temperature exposure	(a) Temperature: 70°C (c) Wait 4 hours before measurement	(b) Duration: 250 hours			
6	Thermal impact	(a) +70°C for 30 minutes ⇒ -25°C for 30 minutes (b) Wait 4 hours before measurement	nutes repeated 3 times			

Requirements: The SAW filer shall remain within the electrical specifications after tests.

Remarks

- SAW devices should not be used in any type of fluid such as water, oil, organic solvent, etc.
- Be certain not to apply voltage exceeding the rated voltage of components.
- Do not operate outside the recommended operating temperature range of components.
- Sudden change of temperature shall be avoided, deterioration of the characteristics can occur.
- Be careful of soldering temperature and duration of components when soldering.
- Do not place soldering iron on the body of components.
- Be careful not to subject the terminals or leads of components to excessive force.
- SAW devices are electrostatic sensitive. Please avoid static voltage during operation and storage.
- Ultrasonic cleaning shall be avoided. Ultrasonic vibration may cause destruction of components.

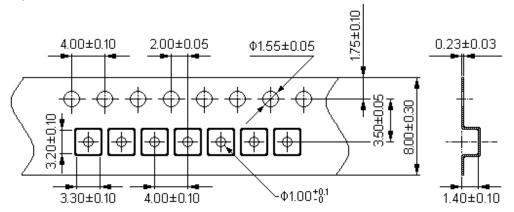
Recommended Land Pattern





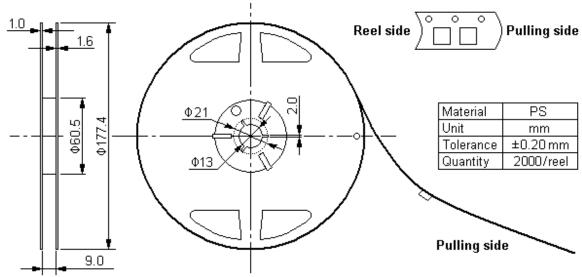
Packing Information

Carrier Tape



Dimensions in mm

Reel Dimensions



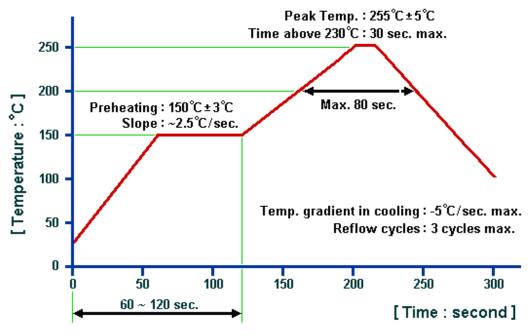
Outer Packing

Туре	Quantity	Dimension	Description	Weight
Carton Box I	10000	190×190×95	anti-static plastic bag & carton box 1 reel / bag	0.85
Carton Box II	20000	190×190×190	5 bags / box (10000 pcs) 10 bags / box (20000 pcs)	1.70

Unit: mm Unit: kg



Recommended Soldering Profile



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- 1. The specifications of this device are subject to change or obsolescence without notice.
- Typically, equipment utilizing this device requires emissions testing and government approval, which is the responsibility of the equipment manufacturer.
- 3. Our liability is only assumed for the Surface Acoustic Wave (SAW) component(s) per se, not for applications, processes and circuits implemented within components or assemblies.
- 4. For questions on technology, prices and delivery, please contact our sales offices or e-mail winnsky@winnsky.com